UNITED STATES PATENT AND TRADEMARK OFFICE

Bib Data Sheet

CONFIRMATION NO. 3141

SERIAL NUMBER 09/945,084	FILING DATE 08/30/2001 RULE	CLASS 438	GROUP ART UNIT 2823	ATTORNEY DOCKET NO. 2001-0128.00

APPLICANTS

   Rich Fogal, Boise, ID;

   Tracy Reynolds, Kuna, ID;
   Timothy Cowles, Boise, ID;

** CONTINUING DATA *************************** none K.N.

** FOREIGN APPLICATIONS ******************** none K.N.

IF REQUIRED, FOREIGN FILING LICENSE GRANTED
** 10/05/2001

Foreign Priority claimed ☐ yes ☒ no				
35 USC 119 (a-d) conditions met ☐ yes ☒ no ☐ Met after Allowance	STATE OR	SHEETS	TOTAL	INDEPENDENT
Verified and Acknowledged _____ _____ Examiner's Signature Initials	COUNTRY ID	DRAWING 7	CLAIMS 23	CLAIMS 6

ADDRESS
Kevin D. Martin
Agent for Applicant
Micron Technology, Inc.
8000 S. Federal Way, MS 525
Boise , ID
83716

TITLE
Method and apparatus for circuit completion through the use of ball bonds or other connections during the formation of semiconductor device

FILING FEE RECEIVED	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	☐ All Fees
		☐ 1.16 Fees (Filing)
		☐ 1.17 Fees (Processing Ext. of time)